

Cannon Universal Contact Series











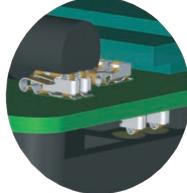


Universal Contact

Universal Contact is an independent SMT contact which provides an electrical connection between a device and a PCB. The contact is manufactured as a single piece stamped product, incorporating pre-load and anti-lift features. The Universal Contact has been designed to replace traditional interfaces where the contact is custom designed into the component. It can be used to connect a number of device components in any direction and configuration using the same interface.

Features & Benefits of the Design

- Range of heights available:
 - 1.3mm contact with the minimum pitch of 1.35mm
 - 1.8mm contact with the minimum pitch of 1.25mm
 - 2.5mm contact the minimum pitch is 1.35mm
 - 3.5 & 4.0mm minimum pitch is 1.45mm
- Solderwell that prevents solder wicking up the contact
- "Side wings" protect the active parts of the contact which prevent contact from overstressing and potential damage
- Domed contact point allows good hertz stress and low contact resistance
- The X-Y-Z movement allows robust connection between the contact and component assembly during shock and vibration
- Compliant with WEEE and RoHS directives.



Additional Advantages of using Universal Contacts

- Qualification time reduction same contact for many components
- Allows standard interface across applications and platforms
- Freedom to position at an angle not fixed by mating component

Applications

Handset

- Solderless component interconnect
- I/O connector / Board to board interconnect
- Battery contact / Antenna contact
- Grounding contact / SIM contact

Laptops & Computers

Memory Stick

Home Electronic Devices / White Goods

- Smoke detectors / Security alarm systems
- Home appliances

Automotive - Keyfob

Medical - CT scan equipment

Industrial - Circuit breaker for GPS beckon

Materials & Finishes

Base material Beryllium Copper
Plating Selective Au in contact area 1 μm
min over Au stripe, 0.05 - 0.1 μm over
Ni 1.0 - 3.0 μm

Electrical

 Contact resistance
 Max 20 mΩ

 Max current rating
 2.0 amps nominal 3.0 amps peak

Environmental

Operating temperature

-40°C and +85°C

Operable in 90% relative humidity
(temp + 40°C)

Solder systems

Infrared and hot air reflow

Vibration

In accordance with IEC 68-2-36

Shock

In accordance with IEC 68-2-27, 30 g

Mechanical See selection table on the right for contact forces at specific mating heights

Maximum mating cycle based on mating PCB plated with 0.05 μ Au over 2.0 μ m Ni = 3,000 cycles. (Wear resistance is subject to mating component surface finish and plating type, increased mating component plating spec = increased mating cycles.)

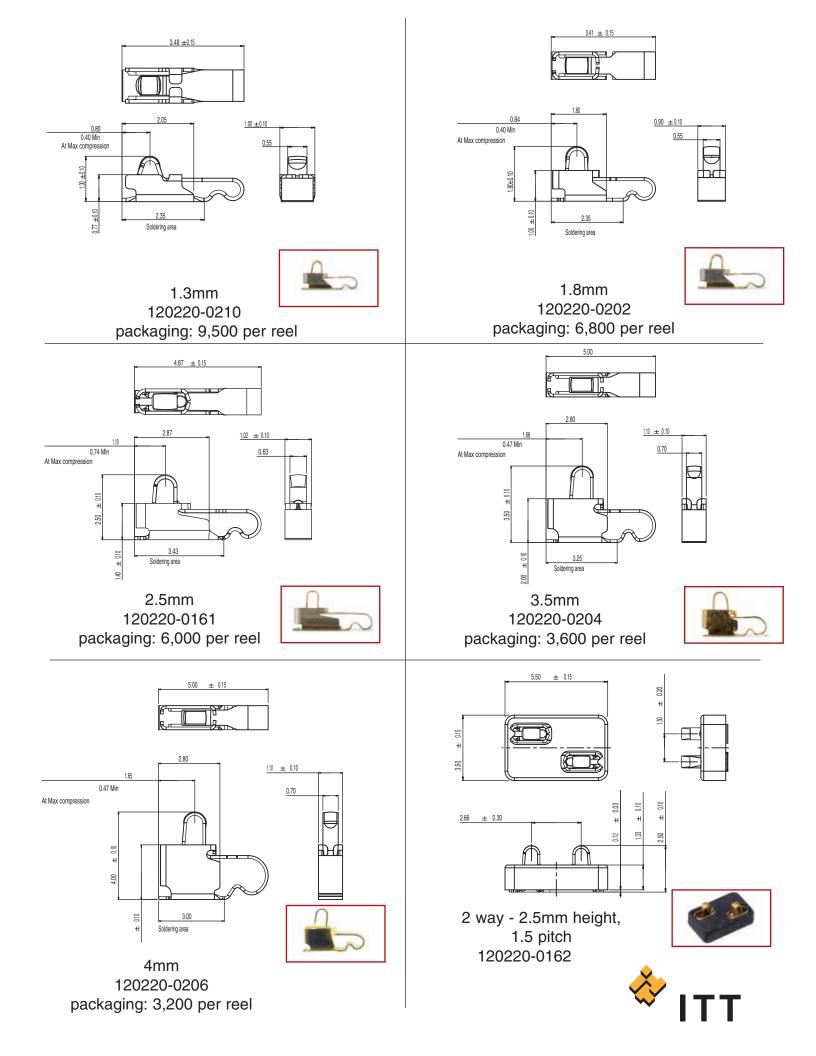
Packaging

Packaged in 12mm wide tape & reel packaging to EIA-481 standards

MATING	1.3mm	1.8mm	2.5mm	3.5mm	4.0mm
	FORCE (N) AT COMPRESSED HEIGHT				
0.90	0.58	ź	8		
1.00	0.51	0.87			
1.10	0.44	0.80			
1.20	0.37	0.74			
1.30	Pre-load	0.68			
1.40		0.62			
1.50		0.56	0.58		
1.60		0.49	0.55		
1.70		0.43	0.52		
1.80		Pre-load	0.49		
1.90			0.46		
2.00			0.42	0.94	
2.10			0.39	0.91	
2.20			0.36	0.87	
2.30			0.33	0.83	
2.40			0.30	0.80	
2.50			Pre-load	0.76	1.30
2.60				0.73	1.27
2.70				0.69	1.24
2.80				0.65	1.22
2.90				0.62	1.19
3.00				0.58	1.16
3.10				0.55	1.13
3.20				0.51	1.11
3.30				0.47	1.08
3.40				0.44	1.05
3.50				Pre-load	1.02
3.60					1.00
3.70					0.97
3.80	3				0.94
3.90	i i				0.91
4.00				1/2	Pre-load
Spring Rate	0.68	0.62	0.32	0.36	0.28
N/mm	20	11		0	

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Specifications and other data are based on information available at the time of printing, and are subject to change without notice.





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